



# SPECIFICATION FOR APPROVAL

CUSTOMER			
NOMINAL FREQUENCY	25.000000 MHz		
PRODUCT TYPE	TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL		
SPEC. NO. ( P/N )	FL2500038		
CUSTOMER P/N			
ISSUE DATE	December 3, 2017		
VERSION	D		

APPROVED	PREPARED	QA
Brenda	Clane	Dong Jang

# **Diodes Incorporated**

No.2, Ziqiang 5th Rd., Zhongli Industrial Park, Zhongli Dist., Taoyuan City 32063, Taiwan (R.O.C.)

TEL: 886-3-451-8888 FAX: 886-3-461-3865 https://www.diodes.com

- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant

E0-R-4-014 Rev. F

FL2500038

VER. D 3-Dec-17

# **VERSION HISTORY**

Version No.	Version Date	Description	Notes
А	Feb.4,2009	Initial Release	
В	Sep.23,2010	Changed Logo	
С	Nov.17,2011	Updated Suggested IR Reflow Profile & Format	
D	Dec.3,2017	Updated logo	

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## **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	25.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	FL	±15	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +85	°C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±20	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	50	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25°C		±2	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	МΩ	Min

※ This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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#### **RELIABILITY SPECIFICATIONS**

#### **MECHANICAL AND ENVIRONMENTAL RATINGS:**

a) FINE LEAK TEST: JESD22-A109 (Condition 1A)

b) GROSS LEAK TEST: JESD22-A109 (Condition C)

c) MOISTURE RESISTANCE: JESD22-A113

d) SHOCK: JESD22-B104 (Condition B)

e) SOLDERABILITY: (RoHS version): J-STD-002

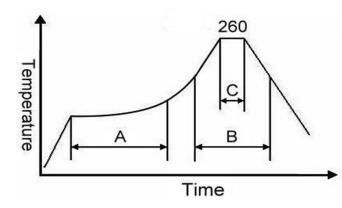
f) VIBRATION: JESD22-B103

g) SOLVENT RESISTANCE: JESD22-B107

h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



N	ote	
13	Ore	

	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

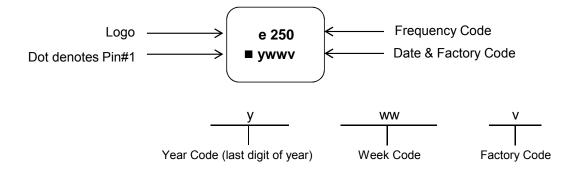
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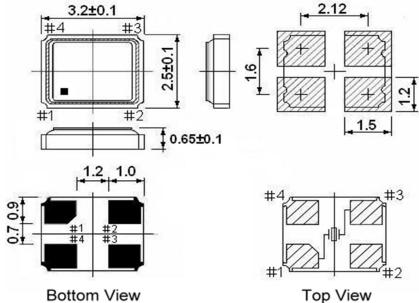
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#### **MARKING**



## MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

# Recommended Land Pattern



\*\* Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

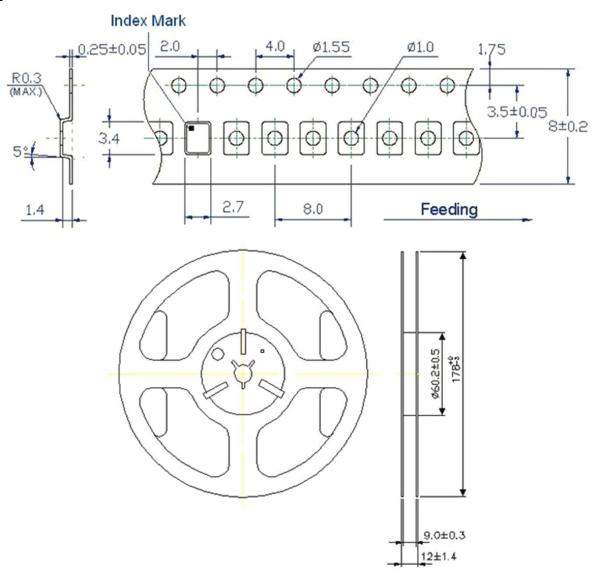
#### Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
  Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

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2. The marking dot denotes i in#1

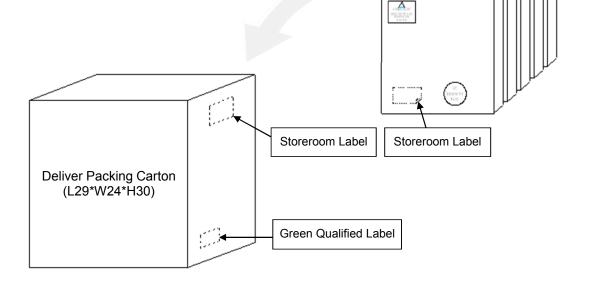
# Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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# **TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL** FL2500038 VER. D 3-Dec-17 **PACKING** Start Begin End 3000pcs-Product Tape Inner Packing Carton Blue Qualified Label Storeroom Label



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